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### Understanding **Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### **Details**

Product Status	Active
Number of LABs/CLBs	5831
Number of Logic Elements/Cells	74637
Total RAM Bits	3170304
Number of I/O	408
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xilinx/xc6slx75-3fg676c">https://www.e-xfl.com/product-detail/xilinx/xc6slx75-3fg676c</a>

Table 10: Differential I/O Standard DC Input and Output Levels

I/O Standard	V <sub>ID</sub>		V <sub>ICM</sub>		V <sub>OD</sub>		V <sub>OCM</sub>		V <sub>OH</sub>	V <sub>OL</sub>
	mV, Min	mV, Max	V, Min	V, Max	mV, Min	mV, Max	V, Min	V, Max	V, Min	V, Max
LVDS_33 <sup>(2)(3)</sup>	100	600	0.3	2.35	247	454	1.125	1.375	—	—
LVDS_25 <sup>(2)(3)</sup>	100	600	0.3	2.35	247	454	1.125	1.375	—	—
BLVDS_25 <sup>(2)(3)</sup>	100	—	0.3	2.35	240	460	Typical 50% V <sub>CCO</sub>		—	—
MINI_LVDS_33	200	600	0.3	1.95	300	600	1.0	1.4	—	—
MINI_LVDS_25	200	600	0.3	1.95	300	600	1.0	1.4	—	—
LVPECL_33 <sup>(2)(3)</sup>	100	1000	0.3	2.8 <sup>(1)</sup>	Inputs only					
LVPECL_25 <sup>(2)(3)</sup>	100	1000	0.3	1.95	Inputs only					
RSDS_33 <sup>(2)(3)</sup>	100	—	0.3	1.5	100	400	1.0	1.4	—	—
RSDS_25 <sup>(2)(3)</sup>	100	—	0.3	1.5	100	400	1.0	1.4	—	—
TMDS_33	150	1200	2.7	3.23 <sup>(1)</sup>	400	800	V <sub>CCO</sub> – 0.405	V <sub>CCO</sub> – 0.190	—	—
PPDS_33 <sup>(2)(3)</sup>	100	400	0.2	2.3	100	400	0.5	1.4	—	—
PPDS_25 <sup>(2)(3)</sup>	100	400	0.2	2.3	100	400	0.5	1.4	—	—
DISPLAY_PORT	190	1260	0.3	2.35	—	—	Typical 50% V <sub>CCO</sub>		—	—
DIFF_MOBILE_DDR	100	—	0.78	1.02	—	—	—	—	90% V <sub>CCO</sub>	10% V <sub>CCO</sub>
DIFF_HSTL_I	100	—	0.68	0.9	—	—	—	—	V <sub>CCO</sub> – 0.4	0.4
DIFF_HSTL_II	100	—	0.68	0.9	—	—	—	—	V <sub>CCO</sub> – 0.4	0.4
DIFF_HSTL_III	100	—	0.68	0.9	—	—	—	—	V <sub>CCO</sub> – 0.4	0.4
DIFF_HSTL_I_18	100	—	0.8	1.1	—	—	—	—	V <sub>CCO</sub> – 0.4	0.4
DIFF_HSTL_II_18	100	—	0.8	1.1	—	—	—	—	V <sub>CCO</sub> – 0.4	0.4
DIFF_HSTL_III_18	100	—	0.8	1.1	—	—	—	—	V <sub>CCO</sub> – 0.4	0.4
DIFF_SSTL3_I	100	—	1.0	1.9	—	—	—	—	V <sub>TT</sub> + 0.6	V <sub>TT</sub> – 0.6
DIFF_SSTL3_II	100	—	1.0	1.9	—	—	—	—	V <sub>TT</sub> + 0.8	V <sub>TT</sub> – 0.8
DIFF_SSTL2_I	100	—	1.0	1.5	—	—	—	—	V <sub>TT</sub> + 0.61	V <sub>TT</sub> – 0.61
DIFF_SSTL2_II	100	—	1.0	1.5	—	—	—	—	V <sub>TT</sub> + 0.81	V <sub>TT</sub> – 0.81
DIFF_SSTL18_I	100	—	0.7	1.1	—	—	—	—	V <sub>TT</sub> + 0.47	V <sub>TT</sub> – 0.47
DIFF_SSTL18_II	100	—	0.7	1.1	—	—	—	—	V <sub>TT</sub> + 0.6	V <sub>TT</sub> – 0.6
DIFF_SSTL15_II	100	—	0.55	0.95	—	—	—	—	V <sub>TT</sub> + 0.4	V <sub>TT</sub> – 0.4

**Notes:**

1. LVPECL\_33 and TMDS\_33 maximum V<sub>ICM</sub> is the lower of V (maximum) or V<sub>CCAUX</sub> – (V<sub>ID</sub>/2)
2. When V<sub>CCAUX</sub> = 3.3V, the DCD can be higher than 5% for V<sub>ICM</sub> < 0.7V when using these I/O standards: LVDS\_25, LVDS\_33, BLVDS\_25, LVPECL\_25, LVPECL\_33, RSDS\_25, RSDS\_33, PPDS\_25, and PPDS\_33.
3. The -1L devices require V<sub>CCAUX</sub> = 2.5V when using the LVDS\_25, LVDS\_33, BLVDS\_25, LVPECL\_25, RSDS\_25, RSDS\_33, PPDS\_25, and PPDS\_33 I/O standards on inputs. LVPECL\_33 is not supported in the -1L devices.

## Performance Characteristics

This section provides the performance characteristics of some common functions and designs implemented in Spartan-6 devices. The numbers reported here are worst-case values; they have all been fully characterized. These values are subject to the same guidelines as the [Switching Characteristics, page 19](#).

**Table 25: Interface Performances**

<b>Description</b>	<b>I/O Resource</b>	<b>Clock Buffer</b>	<b>Data Width</b>	<b>Speed Grade</b>				<b>Units</b>		
				<b>-3</b>	<b>-3N</b>	<b>-2</b>	<b>-1L</b>			
<b>Networking Applications<sup>(1)</sup></b>										
SDR LVDS transmitter or receiver	IOB SDR register	BUFG	—	400	400	375	250	Mb/s		
DDR LVDS transmitter or receiver	ODDR2/IDDR2 register	2 BUFGs	—	800	800	750	500	Mb/s		
SDR LVDS transmitter	OSERDES2	BUFPLL	2	500	500	500	250	Mb/s		
			3	750	750	750	375	Mb/s		
			4-8	1080	1050	950	500	Mb/s		
DDR LVDS transmitter	OSERDES2	2 BUFIO2s	2	500	500	500	250	Mb/s		
			3	750	750	750	375	Mb/s		
			4-8	1080	1050	950	500	Mb/s		
SDR LVDS receiver	ISERDES2 in RETIMED mode	BUFPLL	2	500	500	500	—	Mb/s		
			3	750	750	750	—	Mb/s		
			4-8	1080	1050	950	—	Mb/s		
DDR LVDS receiver	ISERDES2 in RETIMED mode	2 BUFIO2s	2	500	500	500	—	Mb/s		
			3	750	750	750	—	Mb/s		
			4-8	1080	1050	950	—	Mb/s		
<b>Memory Interfaces (Implemented using the Spartan-6 FPGA Memory Controller Block)<sup>(2)</sup></b>										
<b>Standard Performance (Standard V<sub>CCINT</sub>)</b>										
DDR				400	<a href="#">Note 4</a>	400	350	Mb/s		
DDR2				667	<a href="#">Note 4</a>	625	400	Mb/s		
DDR3				800	<a href="#">Note 4</a>	667	—	Mb/s		
LPDDR (Mobile_DDR)				400	<a href="#">Note 4</a>	400	350	Mb/s		
<b>Extended Performance (Requires Extended Performance V<sub>CCINT</sub>)<sup>(3)</sup></b>										
DDR2				800	<a href="#">Note 4</a>	667	—	Mb/s		

**Notes:**

- Refer to [XAPP1064](#), *Source-Synchronous Serialization and Deserialization (up to 1050 Mb/s)* and [UG381](#), *Spartan-6 FPGA SelectIO Resources User Guide*.
- Refer to [UG388](#), *Spartan-6 FPGA Memory Controller User Guide*.
- Extended Memory Controller block performance for DDR2 can be achieved using the extended performance V<sub>CCINT</sub> range from [Table 2](#).
- The LX4 device, all devices in the TQG144 and CPG196 packages, and the -3N speed grade do not support a Memory Controller Block.

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T <sub>IOPI</sub>				T <sub>IOOP</sub>				T <sub>IOTP</sub>				Units	
	Speed Grade				Speed Grade				Speed Grade					
	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>		
LVCMOS33, Fast, 8 mA	1.34	1.46	1.59	1.82	2.07	2.21	2.41	3.03	2.07	2.21	2.41	3.03	ns	
LVCMOS33, Fast, 12 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns	
LVCMOS33, Fast, 16 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns	
LVCMOS33, Fast, 24 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns	
LVCMOS25, QUIETIO, 2 mA	0.82	0.94	1.07	1.31	4.81	4.95	5.15	5.79	4.81	4.95	5.15	5.79	ns	
LVCMOS25, QUIETIO, 4 mA	0.82	0.94	1.07	1.31	3.70	3.84	4.04	4.66	3.70	3.84	4.04	4.66	ns	
LVCMOS25, QUIETIO, 6 mA	0.82	0.94	1.07	1.31	3.46	3.60	3.80	4.38	3.46	3.60	3.80	4.38	ns	
LVCMOS25, QUIETIO, 8 mA	0.82	0.94	1.07	1.31	3.20	3.34	3.54	4.12	3.20	3.34	3.54	4.12	ns	
LVCMOS25, QUIETIO, 12 mA	0.82	0.94	1.07	1.31	2.83	2.97	3.17	3.75	2.83	2.97	3.17	3.75	ns	
LVCMOS25, QUIETIO, 16 mA	0.82	0.94	1.07	1.31	2.64	2.78	2.98	3.64	2.64	2.78	2.98	3.64	ns	
LVCMOS25, QUIETIO, 24 mA	0.82	0.94	1.07	1.31	2.45	2.59	2.79	3.42	2.45	2.59	2.79	3.42	ns	
LVCMOS25, Slow, 2 mA	0.82	0.94	1.07	1.31	3.78	3.92	4.12	4.76	3.78	3.92	4.12	4.76	ns	
LVCMOS25, Slow, 4 mA	0.82	0.94	1.07	1.31	2.79	2.93	3.13	3.73	2.79	2.93	3.13	3.73	ns	
LVCMOS25, Slow, 6 mA	0.82	0.94	1.07	1.31	2.73	2.87	3.07	3.66	2.73	2.87	3.07	3.66	ns	
LVCMOS25, Slow, 8 mA	0.82	0.94	1.07	1.31	2.48	2.62	2.82	3.42	2.48	2.62	2.82	3.42	ns	
LVCMOS25, Slow, 12 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.95	2.01	2.15	2.35	2.95	ns	
LVCMOS25, Slow, 16 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.95	2.01	2.15	2.35	2.95	ns	
LVCMOS25, Slow, 24 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.94	2.01	2.15	2.35	2.94	ns	
LVCMOS25, Fast, 2 mA	0.82	0.94	1.07	1.31	3.35	3.49	3.69	4.31	3.35	3.49	3.69	4.31	ns	
LVCMOS25, Fast, 4 mA	0.82	0.94	1.07	1.31	2.25	2.39	2.59	3.22	2.25	2.39	2.59	3.22	ns	
LVCMOS25, Fast, 6 mA	0.82	0.94	1.07	1.31	2.09	2.23	2.43	3.05	2.09	2.23	2.43	3.05	ns	
LVCMOS25, Fast, 8 mA	0.82	0.94	1.07	1.31	2.02	2.16	2.36	2.98	2.02	2.16	2.36	2.98	ns	
LVCMOS25, Fast, 12 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns	
LVCMOS25, Fast, 16 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns	
LVCMOS25, Fast, 24 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns	
LVCMOS18, QUIETIO, 2 mA	1.18	1.30	1.43	2.04	5.92	6.06	6.26	6.80	5.92	6.06	6.26	6.80	ns	
LVCMOS18, QUIETIO, 4 mA	1.18	1.30	1.43	2.04	4.74	4.88	5.08	5.63	4.74	4.88	5.08	5.63	ns	
LVCMOS18, QUIETIO, 6 mA	1.18	1.30	1.43	2.04	4.05	4.19	4.39	4.96	4.05	4.19	4.39	4.96	ns	
LVCMOS18, QUIETIO, 8 mA	1.18	1.30	1.43	2.04	3.71	3.85	4.05	4.63	3.71	3.85	4.05	4.63	ns	
LVCMOS18, QUIETIO, 12 mA	1.18	1.30	1.43	2.04	3.35	3.49	3.69	4.27	3.35	3.49	3.69	4.27	ns	
LVCMOS18, QUIETIO, 16 mA	1.18	1.30	1.43	2.04	3.20	3.34	3.54	4.14	3.20	3.34	3.54	4.14	ns	
LVCMOS18, QUIETIO, 24 mA	1.18	1.30	1.43	2.04	2.96	3.10	3.30	3.98	2.96	3.10	3.30	3.98	ns	
LVCMOS18, Slow, 2 mA	1.18	1.30	1.43	2.04	4.62	4.76	4.96	5.54	4.62	4.76	4.96	5.54	ns	
LVCMOS18, Slow, 4 mA	1.18	1.30	1.43	2.04	3.69	3.83	4.03	4.60	3.69	3.83	4.03	4.60	ns	
LVCMOS18, Slow, 6 mA	1.18	1.30	1.43	2.04	3.00	3.14	3.34	3.94	3.00	3.14	3.34	3.94	ns	
LVCMOS18, Slow, 8 mA	1.18	1.30	1.43	2.04	2.19	2.33	2.53	3.17	2.19	2.33	2.53	3.17	ns	
LVCMOS18, Slow, 12 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns	
LVCMOS18, Slow, 16 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns	

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T <sub>IOP1</sub>				T <sub>IOP0</sub>				T <sub>IOTP</sub>				Units	
	Speed Grade				Speed Grade				Speed Grade					
	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>		
LVCMOS12, Fast, 2 mA	0.91	1.03	1.16	1.51	3.46	3.60	3.80	4.44	3.46	3.60	3.80	4.44	ns	
LVCMOS12, Fast, 4 mA	0.91	1.03	1.16	1.51	2.35	2.49	2.69	3.30	2.35	2.49	2.69	3.30	ns	
LVCMOS12, Fast, 6 mA	0.91	1.03	1.16	1.51	1.79	1.93	2.13	2.75	1.79	1.93	2.13	2.75	ns	
LVCMOS12, Fast, 8 mA	0.91	1.03	1.16	1.51	1.68	1.82	2.02	2.64	1.68	1.82	2.02	2.64	ns	
LVCMOS12, Fast, 12 mA	0.91	1.03	1.16	1.51	1.66	1.80	2.00	2.62	1.66	1.80	2.00	2.62	ns	
LVCMOS12_JEDEC, QUIETIO, 2 mA	1.50	1.62	1.75	1.88	6.39	6.53	6.73	7.31	6.39	6.53	6.73	7.31	ns	
LVCMOS12_JEDEC, QUIETIO, 4 mA	1.50	1.62	1.75	1.88	4.98	5.12	5.32	5.88	4.98	5.12	5.32	5.88	ns	
LVCMOS12_JEDEC, QUIETIO, 6 mA	1.50	1.62	1.75	1.88	4.67	4.81	5.01	5.54	4.67	4.81	5.01	5.54	ns	
LVCMOS12_JEDEC, QUIETIO, 8 mA	1.50	1.62	1.75	1.88	4.23	4.37	4.57	5.22	4.23	4.37	4.57	5.22	ns	
LVCMOS12_JEDEC, QUIETIO, 12 mA	1.50	1.62	1.75	1.88	3.99	4.13	4.33	4.94	3.99	4.13	4.33	4.94	ns	
LVCMOS12_JEDEC, Slow, 2 mA	1.50	1.62	1.75	1.88	5.00	5.14	5.34	5.90	5.00	5.14	5.34	5.90	ns	
LVCMOS12_JEDEC, Slow, 4 mA	1.50	1.62	1.75	1.88	2.85	2.99	3.19	3.80	2.85	2.99	3.19	3.80	ns	
LVCMOS12_JEDEC, Slow, 6 mA	1.50	1.62	1.75	1.88	2.76	2.90	3.10	3.72	2.76	2.90	3.10	3.72	ns	
LVCMOS12_JEDEC, Slow, 8 mA	1.50	1.62	1.75	1.88	2.35	2.49	2.69	3.30	2.35	2.49	2.69	3.30	ns	
LVCMOS12_JEDEC, Slow, 12 mA	1.50	1.62	1.75	1.88	2.09	2.23	2.43	3.05	2.09	2.23	2.43	3.05	ns	
LVCMOS12_JEDEC, Fast, 2 mA	1.50	1.62	1.75	1.88	3.46	3.60	3.80	4.42	3.46	3.60	3.80	4.42	ns	
LVCMOS12_JEDEC, Fast, 4 mA	1.50	1.62	1.75	1.88	2.35	2.49	2.69	3.31	2.35	2.49	2.69	3.31	ns	
LVCMOS12_JEDEC, Fast, 6 mA	1.50	1.62	1.75	1.88	1.79	1.93	2.13	2.76	1.79	1.93	2.13	2.76	ns	
LVCMOS12_JEDEC, Fast, 8 mA	1.50	1.62	1.75	1.88	1.69	1.83	2.03	2.65	1.69	1.83	2.03	2.65	ns	
LVCMOS12_JEDEC, Fast, 12 mA	1.50	1.62	1.75	1.88	1.66	1.80	2.00	2.62	1.66	1.80	2.00	2.62	ns	

**Notes:**

1. The -1L values listed in this table are also applicable to the Spartan-6Q devices.
2. Devices with a -1L speed grade do not support Xilinx PCI IP.

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair (Cont'd)

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
3.3V	LVCMOS33	2	Fast	42	46	42	44
			Slow	50	55	50	49
			QuietIO	60	68	60	60
		4	Fast	21	27	21	25
			Slow	32	37	32	32
			QuietIO	39	42	39	37
		6	Fast	14	19	14	17
			Slow	19	25	19	22
			QuietIO	29	30	29	25
		8	Fast	11	15	11	14
			Slow	15	20	15	18
			QuietIO	25	24	25	20
		12	Fast	1	3	1	1
			Slow	2	5	2	2
			QuietIO	4	9	4	7
		16	Fast	1	2	1	1
			Slow	1	5	1	1
			QuietIO	3	10	3	8
		24	Fast	1	2	1	1
			Slow	2	5	2	1
			QuietIO	7	9	7	7

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair (Cont'd)

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair					
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324			
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5		
3.3V	LVTTL	2	Fast	53	65	53	62		
			Slow	70	80	70	73		
			QuietIO	79	89	79	91		
		4	Fast	23	30	23	27		
			Slow	34	41	34	37		
			QuietIO	44	49	44	46		
		6	Fast	16	21	16	20		
			Slow	21	28	21	25		
			QuietIO	34	39	34	34		
		8	Fast	12	16	12	15		
			Slow	16	22	16	19		
			QuietIO	27	28	27	24		
		12	Fast	1	3	1	1		
			Slow	2	5	2	4		
			QuietIO	2	10	2	8		
		16	Fast	1	3	1	1		
			Slow	1	7	1	2		
			QuietIO	3	11	3	8		
		24	Fast	1	2	1	1		
			Slow	2	5	2	2		
			QuietIO	8	9	8	8		
PCI33_3				18	19	18	19		
PCI66_3				18	19	18	19		
SSTL_3_I				5	8	5	8		
SSTL_3_II				3	5	3	3		
DIFF_SSTL_3_I				15	24	15	24		
DIFF_SSTL_3_II				9	15	9	9		
SDIO				17	18	17	15		

## Input/Output Logic Switching Characteristics

Table 35: ILOGIC2 Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Setup/Hold</b>						
T <sub>ICE0CK</sub> /T <sub>ICKCE0</sub>	CE0 pin Setup/Hold with respect to CLK	0.56/ -0.30	0.56/ -0.25	0.79/ -0.22	1.21/ -0.52	ns
T <sub>ISRCK</sub> /T <sub>ICKSR</sub>	SR pin Setup/Hold with respect to CLK	0.74/ -0.23	0.74/ -0.22	0.98/ -0.20	1.31/ -0.45	ns
T <sub>IDOCK</sub> /T <sub>IOCKD</sub>	D pin Setup/Hold with respect to CLK without Delay	1.19/ -0.83	1.36/ -0.83	1.73/ -0.83	2.18/ -1.77	ns
T <sub>IDOCKD</sub> /T <sub>IOCKDD</sub>	DDLY pin Setup/Hold with respect to CLK (using IODELAY2)	0.31/ 0.00	0.47/ 0.00	0.54/ 0.00	0.63/ -0.39	ns
<b>Combinatorial</b>						
T <sub>IDI</sub>	D pin to O pin propagation delay, no Delay	0.95	1.28	1.53	2.25	ns
T <sub>IDID</sub>	DDLY pin to O pin propagation delay (using IODELAY2)	0.23	0.39	0.44	0.74	ns
<b>Sequential Delays</b>						
T <sub>IDLO</sub>	D pin to Q pin using flip-flop as a latch without Delay	1.56	1.86	2.39	3.49	ns
T <sub>IDLOD</sub>	DDLY pin to Q1 pin using flip-flop as a latch (using IODELAY2)	0.68	0.97	1.20	1.94	ns
T <sub>ICKQ</sub>	CLK to Q outputs for XC devices	1.03	1.24	1.43	2.11	ns
	CLK to Q outputs for XA and XQ devices	1.38	N/A	1.78	2.11	ns
T <sub>TRQ_ILOGIC2</sub>	SR pin to Q outputs	1.81	1.81	2.50	3.05	ns

Table 36: OLOGIC2 Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Setup/Hold</b>						
T <sub>ODCK</sub> /T <sub>OCKD</sub>	D1/D2 pins Setup/Hold with respect to CLK	0.81/ -0.05	0.86/ -0.05	1.18/ 0.00	1.73/ -0.27	ns
T <sub>OOC ECK</sub> /T <sub>OCKOCE</sub>	OCE pin Setup/Hold with respect to CLK	0.75/ -0.10	0.75/ -0.10	1.01/ -0.05	1.66/ -0.23	ns
T <sub>OSRCK</sub> /T <sub>OCKSR</sub>	SR pin Setup/Hold with respect to CLK	0.70/ -0.28	0.79/ -0.28	1.03/ -0.23	1.39/ -0.47	ns
T <sub>OTCK</sub> /T <sub>OCKT</sub>	T1/T2 pins Setup/Hold with respect to CLK	0.24/ -0.08	0.56/ -0.06	0.83/ -0.01	0.99/ -0.19	ns
T <sub>OTCECK</sub> /T <sub>OCKTCE</sub>	TCE pin Setup/Hold with respect to CLK	0.58/ -0.06	0.72/ -0.06	1.18/ -0.01	1.51/ -0.13	ns
<b>Sequential Delays</b>						
T <sub>OCKQ</sub>	CLK to OQ/TQ out for XC devices	0.48	0.51	0.74	0.74	ns
	CLK to OQ/TQ out for XA and XQ devices	0.85	N/A	1.16	0.74	ns
T <sub>TRQ_OLOGIC2</sub>	SR pin to OQ/TQ out	1.81	1.81	2.50	3.05	ns

## Input Serializer/Deserializer Switching Characteristics

Table 37: ISERDES2 Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Setup/Hold for Control Lines</b>						
T <sub>ISCKC_BITSLIP</sub> / T <sub>ISCKC_BITSLIP</sub>	BITSLIP pin Setup/Hold with respect to CLKDIV	0.16/ -0.09	0.20/ -0.09	0.31/ -0.09	0.34/ -0.14	ns
T <sub>ISCKC_CE</sub> / T <sub>ISCKC_CE</sub>	CE pin Setup/Hold with respect to CLK	0.71/ -0.47	0.71/ -0.42	0.97/ -0.42	1.39/ -0.71	ns
<b>Setup/Hold for Data Lines</b>						
T <sub>ISDCK_D</sub> / T <sub>ISCKD_D</sub>	D pin Setup/Hold with respect to CLK	0.24/ -0.15	0.25/ -0.05	0.29/ -0.05	0.09/ -0.05	ns
T <sub>ISDCK_DDLY</sub> / T <sub>ISCKD_DDLY</sub>	DDLY pin Setup/Hold with respect to CLK (using IODELAY2)	-0.25/ 0.30	-0.25/ 0.42	-0.25/ 0.56	-0.54/ 0.67	ns
T <sub>ISDCK_D_DDR</sub> / T <sub>ISCKD_D_DDR</sub>	D pin Setup/Hold with respect to CLK at DDR mode	-0.03/ 0.04	-0.03/ 0.16	-0.03/ 0.18	-0.05/ 0.12	ns
T <sub>ISDCK_DDLY_DDR</sub> / T <sub>ISCKD_DDLY_DDR</sub>	D pin Setup/Hold with respect to CLK at DDR mode (using IODELAY2)	-0.40/ 0.48	-0.40/ 0.53	-0.40/ 0.71	-0.71/ 0.86	ns
<b>Sequential Delays</b>						
T <sub>ISCKO_Q</sub>	CLKDIV to out at Q pin	1.30	1.44	2.02	2.22	ns
F <sub>CLKDIV</sub>	CLKDIV maximum frequency	270	262.5	250	125	MHz

## Output Serializer/Deserializer Switching Characteristics

Table 38: OSERDES2 Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Setup/Hold</b>						
T <sub>OSDCK_D</sub> / T <sub>OSCKD_D</sub>	D input Setup/Hold with respect to CLKDIV	-0.03/ 1.02	-0.03/ 1.17	-0.03/ 1.27	-0.02/ 0.23	ns
T <sub>OSDCK_T</sub> / T <sub>OSCKD_T</sub> <sup>(1)</sup>	T input Setup/Hold with respect to CLK	-0.05/ 1.03	-0.05/ 1.13	-0.05/ 1.23	-0.05/ 0.24	ns
T <sub>OSCCK_OCE</sub> / T <sub>OSCKC_OCE</sub>	OCE input Setup/Hold with respect to CLK	0.12/ -0.03	0.15/ -0.03	0.24/ -0.03	0.28/ -0.17	ns
T <sub>OSCCK_TCE</sub> / T <sub>OSCKC_TCE</sub>	TCE input Setup/Hold with respect to CLK	0.14/ -0.08	0.17/ -0.08	0.27/ -0.08	0.31/ -0.16	ns
<b>Sequential Delays</b>						
T <sub>OSCKO_OQ</sub>	Clock to out from CLK to OQ	0.94	1.11	1.51	1.89	ns
T <sub>OSCKO_TQ</sub>	Clock to out from CLK to TQ	0.94	1.11	1.51	1.91	ns
F <sub>CLKDIV</sub>	CLKDIV maximum frequency	270	262.5	250	125	MHz

**Notes:**

1. T<sub>OSDCK\_T2</sub> / T<sub>OSCKD\_T2</sub> (T input setup/hold with respect to CLKDIV) are reported as T<sub>OSDCK\_T</sub> / T<sub>OSCKD\_T</sub> in TRACE report.

## DCM Switching Characteristics

Table 53: Operating Frequency Ranges and Conditions for the Delay-Locked Loop (DLL)<sup>(1)</sup>

Symbol	Description	Speed Grade								Units	
		-3		-3N		-2		-1L			
		Min	Max	Min	Max	Min	Max	Min	Max		
<b>Input Frequency Ranges</b>											
CLKIN_FREQ_DLL	Frequency of the CLKIN clock input when the CLKDV output is not used.	5 <sup>(2)</sup>	280 <sup>(3)</sup>	5 <sup>(2)</sup>	280 <sup>(3)</sup>	5 <sup>(2)</sup>	250 <sup>(3)</sup>	5 <sup>(2)</sup>	175 <sup>(3)</sup>	MHz	
	Frequency of the CLKIN clock input when using the CLKDV output.	5 <sup>(2)</sup>	280 <sup>(3)</sup>	5 <sup>(2)</sup>	280 <sup>(3)</sup>	5 <sup>(2)</sup>	250 <sup>(3)</sup>	5 <sup>(2)</sup>	133 <sup>(3)</sup>	MHz	
<b>Input Pulse Requirements</b>											
CLKIN_PULSE	CLKIN pulse width as a percentage of the CLKIN period for CLKIN_FREQ_DLL < 150 MHz	40	60	40	60	40	60	40	60	%	
	CLKIN pulse width as a percentage of the CLKIN period for CLKIN_FREQ_DLL > 150 MHz	45	55	45	55	45	55	45	55	%	
<b>Input Clock Jitter Tolerance and Delay Path Variation<sup>(4)</sup></b>											
CLKIN_CYC_JITT_DLL_LF	Cycle-to-cycle jitter at the CLKIN input for CLKIN_FREQ_DLL < 150 MHz	–	±300	–	±300	–	±300	–	±300	ps	
CLKIN_CYC_JITT_DLL_HF	Cycle-to-cycle jitter at the CLKIN input for CLKIN_FREQ_DLL > 150 MHz.	–	±150	–	±150	–	±150	–	±150	ps	
CLKIN_PER_JITT_DLL	Period jitter at the CLKIN input.	–	±1	–	±1	–	±1	–	±1	ns	
CLKFB_DELAY_VAR_EXT	Allowable variation of the off-chip feedback delay from the DCM output to the CLKFB input.	–	±1	–	±1	–	±1	–	±1	ns	

### Notes:

1. DLL specifications apply when using any of the DLL outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, or CLKDV.
2. When operating independently of the DLL, the DFS supports lower CLKIN\_FREQ\_DLL frequencies. See Table 55.
3. The CLKIN\_DIVIDE\_BY\_2 attribute increases the effective input frequency range. When set to TRUE, the input clock frequency is divided by two as it enters the DCM. Input clock frequencies for the clock buffer being used can be increased up to the F<sub>MAX</sub> (see Table 48 and Table 49 for BUFG and BUFIO2 limits). When used with CLK\_FEEDBACK=2X, the input clock frequency matches the frequency for CLK2X, and is limited to CLKOUT\_FREQ\_2X.
4. CLKIN\_FREQ\_DLL input jitter beyond these limits can cause the DCM to lose LOCK, indicated by the LOCKED output deasserting. The user must then reset the DCM.
5. When using both DCMs in a CMT, both DCMs must be LOCKED.

Table 56: Switching Characteristics for the Digital Frequency Synthesizer (DFS) for DCM\_SP<sup>(1)</sup>

Symbol	Description	Speed Grade								Units	
		-3		-3N		-2		-1L			
		Min	Max	Min	Max	Min	Max	Min	Max		
<b>Output Frequency Ranges</b>											
CLKOUT_FREQ_FX	Frequency for the CLKFX and CLKFX180 outputs	5	375	5	375	5	333	5	200	MHz	
<b>Output Clock Jitter<sup>(2)(3)</sup></b>											
CLKOUT_PER_JITT_FX	Period jitter at the CLKFX and CLKFX180 outputs. When CLKIN < 20 MHz	Use the Clocking Wizard								ps	
	Period jitter at the CLKFX and CLKFX180 outputs. When CLKIN > 20 MHz	Typical = ±(1% of CLKFX period + 100)								ps	
<b>Duty Cycle<sup>(4)(5)</sup></b>											
CLKOUT_DUTY_CYCLE_FX	Duty cycle precision for the CLKFX and CLKFX180 outputs including the BUFGMUX and clock tree duty-cycle distortion	Maximum = ±(1% of CLKFX period + 350)								ps	
<b>Phase Alignment<sup>(5)</sup></b>											
CLKOUT_PHASE_FX	Phase offset between the DFS CLKFX output and the DLL CLK0 output when both the DFS and DLL are used	–	±200	–	±200	–	±200	–	±250	ps	
CLKOUT_PHASE_FX180	Phase offset between the DFS CLKFX180 output and the DLL CLK0 output when both the DFS and DLL are used	Maximum = ±(1% of CLKFX period + 200)								ps	
<b>LOCKED Time</b>											
LOCK_FX <sup>(2)</sup>	When FCLKIN < 50 MHz, the time from deassertion at the DCM's reset input to the rising transition at its LOCKED output. The DFS asserts LOCKED when the CLKFX and CLKFX180 signals are valid. When using both the DLL and the DFS, use the longer locking time.	–	5	–	5	–	5	–	5	ms	
	When FCLKIN > 50 MHz, the time from deassertion at the DCM's reset input to the rising transition at its LOCKED output. The DFS asserts LOCKED when the CLKFX and CLKFX180 signals are valid. When using both the DLL and the DFS, use the longer locking time.	–	0.45	–	0.45	–	0.45	–	0.60	ms	

**Notes:**

- The values in this table are based on the operating conditions described in Table 2 and Table 55.
- For optimal jitter tolerance and a faster LOCK time, use the CLKIN\_PERIOD attribute.
- Output jitter is characterized with no input jitter. Output jitter strongly depends on the environment, including the number of SSOs, the output drive strength, CLB utilization, CLB switching activities, switching frequency, power supply, and PCB design. The actual maximum output jitter depends on the system application.
- The CLKFX, CLKFXDV, and CLKFX180 outputs have a duty cycle of approximately 50%.
- Some duty cycle and alignment specifications include a percentage of the CLKFX output period. For example, this data sheet specifies a maximum CLKFX jitter of ±(1% of CLKFX period + 200 ps). Assuming that the CLKFX output frequency is 100 MHz, the equivalent CLKFX period is 10 ns, and 1% of 10 ns is 0.1 ns or 100 ps. Accordingly, the maximum jitter is ±(100 ps + 200 ps) = ±300 ps.

Table 57: Switching Characteristics for the Digital Frequency Synthesizer DFS (DCM\_CLKGEN)<sup>(1)</sup> (Cont'd)

Symbol	Description	Speed Grade								Units	
		-3		-3N		-2		-1L			
		Min	Max	Min	Max	Min	Max	Min	Max		
<b>Spread Spectrum</b>											
F_CLKIN_FIXED_SPREAD_SPECTRUM	Frequency of the CLKIN input for fixed spread spectrum (SPREAD_SPECTRUM = CENTER_LOW_SPREAD / CENTER_HIGH_SPREAD)	30	200	30	200	30	200	30	200	MHz	
T_CENTER_LOW_SPREAD <sup>(6)</sup>	Spread at the CLKFX output for fixed spread spectrum (SPREAD_SPECTRUM = CENTER_LOW_SPREAD)	Typical = $\frac{100}{\text{CLKFX\_DIVIDE}}$ Maximum = 250								ps	
T_CENTER_HIGH_SPREAD <sup>(6)</sup>	Spread at the CLKFX output for fixed spread spectrum (SPREAD_SPECTRUM = CENTER_HIGH_SPREAD)	Typical = $\frac{240}{\text{CLKFX\_DIVIDE}}$ Maximum = 400								ps	
F_MOD_FIXED_SPREAD_SPECTRUM <sup>(6)</sup>	Average modulation frequency when using fixed spread spectrum (SPREAD_SPECTRUM = CENTER_LOW_SPREAD / CENTER_HIGH_SPREAD)	Typical = $F_{IN}/1024$								MHz	

**Notes:**

- The values in this table are based on the operating conditions described in Table 2 and Table 55.
- For optimal jitter tolerance and a faster LOCK time, use the CLKIN\_PERIOD attribute.
- Output jitter is characterized with no input jitter. Output jitter strongly depends on the environment, including the number of SSOs, the output drive strength, CLB utilization, CLB switching activities, switching frequency, power supply, and PCB design. The actual maximum output jitter depends on the system application.
- The CLKFX, CLKFXDV, and CLKFX180 outputs have a duty cycle of approximately 50%.
- Some duty-cycle and alignment specifications include a percentage of the CLKFX output period. For example, this data sheet specifies a maximum CLKFX jitter of  $\pm(1\% \text{ of CLKFX period} + 200 \text{ ps})$ . Assuming that the CLKFX output frequency is 100 MHz, the equivalent CLKFX period is 10 ns, and 1% of 10 ns is 0.1 ns or 100 ps. Accordingly, the maximum jitter is  $\pm(100 \text{ ps} + 200 \text{ ps}) = \pm300 \text{ ps}$ .
- When using CENTER\_LOW\_SPREAD, CENTER\_HIGH\_SPREAD, the valid values for CLKFX\_MULTIPLY are limited to 2 through 32, and the valid values for CLKFX\_DIVIDE are limited to 1 through 4.

Table 58: Recommended Operating Conditions for the Phase-Shift Clock in Variable Phase Mode (DCM\_SP) or Dynamic Frequency Synthesis (DCM\_CLKGEN)

Symbol	Description	Speed Grade								Units	
		-3		-3N		-2		-1L			
		Min	Max	Min	Max	Min	Max	Min	Max		
<b>Operating Frequency Ranges</b>											
PSCLK_FREQ	Frequency for the PSCLK (DCM_SP) or PROGCLK (DCM_CLKGEN) input.	1	167	1	167	1	167	1	100	MHz	
<b>Input Pulse Requirements</b>											
PSCLK_PULSE	PSCLK (DCM_SP) or PROGCLK (DCM_CLKGEN) pulse width as a percentage of the clock period.	40	60	40	60	40	60	40	60	%	

Table 65: Global Clock Input to Output Delay With DCM in Source-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> DCM in Source-Synchronous Mode.							
T <sub>CLOCKOFDCM_0</sub>	Global Clock and OUTFF <i>with</i> DCM	XC6SLX4	5.03	N/A	7.21	8.05	ns
		XC6SLX9	5.03	6.13	7.21	8.05	ns
		XC6SLX16	5.08	5.51	6.44	7.96	ns
		XC6SLX25	4.81	5.13	5.69	7.94	ns
		XC6SLX25T	4.81	5.13	5.69	N/A	ns
		XC6SLX45	5.26	5.69	6.63	7.92	ns
		XC6SLX45T	5.26	5.69	6.63	N/A	ns
		XC6SLX75	4.77	5.18	5.88	7.95	ns
		XC6SLX75T	4.77	5.18	5.88	N/A	ns
		XC6SLX100	4.72	5.11	5.76	8.59	ns
		XC6SLX100T	4.76	5.11	5.76	N/A	ns
		XC6SLX150	4.90	5.30	5.93	7.93	ns
		XC6SLX150T	4.90	5.30	5.93	N/A	ns
		XA6SLX4	5.35	N/A	7.21	N/A	ns
		XA6SLX9	5.35	N/A	7.21	N/A	ns
		XA6SLX16	5.42	N/A	6.44	N/A	ns
		XA6SLX25	5.13	N/A	5.69	N/A	ns
		XA6SLX25T	5.13	N/A	5.79	N/A	ns
		XA6SLX45	5.58	N/A	6.63	N/A	ns
		XA6SLX45T	5.58	N/A	6.63	N/A	ns
		XA6SLX75	5.09	N/A	5.87	N/A	ns
		XA6SLX75T	5.09	N/A	5.87	N/A	ns
		XA6SLX100	N/A	N/A	6.44	N/A	ns
		XQ6SLX75	N/A	N/A	5.87	7.95	ns
		XQ6SLX75T	5.09	N/A	5.87	N/A	ns
		XQ6SLX150	N/A	N/A	6.06	7.93	ns
		XQ6SLX150T	5.50	N/A	6.06	N/A	ns

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM output jitter is already included in the timing calculation.

Table 68: Global Clock Input to Output Delay With DCM and PLL in System-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> DCM in System-Synchronous Mode and PLL in DCM2PLL Mode.							
$T_{ICKOFDCM\_PLL}$	Global Clock and OUTFF with DCM and PLL	XC6SLX4	4.78	N/A	6.32	7.09	ns
		XC6SLX9	4.78	5.24	6.32	7.09	ns
		XC6SLX16	4.70	5.12	5.94	6.63	ns
		XC6SLX25	4.70	5.09	5.92	7.30	ns
		XC6SLX25T	4.70	5.09	5.92	N/A	ns
		XC6SLX45	4.63	4.98	5.83	7.26	ns
		XC6SLX45T	4.63	4.98	5.83	N/A	ns
		XC6SLX75	4.68	5.04	5.88	6.90	ns
		XC6SLX75T	4.68	5.04	5.88	N/A	ns
		XC6SLX100	4.72	5.07	5.92	7.77	ns
		XC6SLX100T	4.76	5.07	5.92	N/A	ns
		XC6SLX150	4.44	4.73	5.31	6.96	ns
		XC6SLX150T	4.44	4.73	5.31	N/A	ns
		XA6SLX4	5.07	N/A	6.18	N/A	ns
		XA6SLX9	5.07	N/A	6.18	N/A	ns
		XA6SLX16	5.22	N/A	5.77	N/A	ns
		XA6SLX25	5.01	N/A	5.80	N/A	ns
		XA6SLX25T	5.01	N/A	5.90	N/A	ns
		XA6SLX45	4.93	N/A	5.67	N/A	ns
		XA6SLX45T	4.93	N/A	5.67	N/A	ns
		XA6SLX75	4.94	N/A	5.70	N/A	ns
		XA6SLX75T	4.94	N/A	5.70	N/A	ns
		XA6SLX100	N/A	N/A	5.77	N/A	ns
		XQ6SLX75	N/A	N/A	5.70	6.90	ns
		XQ6SLX75T	4.94	N/A	5.70	N/A	ns
		XQ6SLX150	N/A	N/A	5.31	6.96	ns
		XQ6SLX150T	5.02	N/A	5.31	N/A	ns

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM and PLL output jitter are already included in the timing calculation.

## Spartan-6 Device Pin-to-Pin Input Parameter Guidelines

All devices are 100% functionally tested. The representative values for typical pin locations and normal clock loading are listed in [Table 70](#) through [Table 77](#). Values are expressed in nanoseconds unless otherwise noted.

**Table 70: Global Clock Setup and Hold Without DCM or PLL (No Delay)**

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
<b>Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMS25 Standard.<sup>(1)</sup></b>							
$T_{PSND}/T_{PHND}$	No Delay Global Clock and IFF <sup>(3)</sup> without DCM or PLL	XC6SLX4	0.10/1.56	N/A	0.10/1.83	0.07/2.54	ns
		XC6SLX9	0.10/1.56	0.10/1.57	0.10/1.84	0.07/2.54	ns
		XC6SLX16	0.12/1.42	0.12/1.48	0.12/1.64	0.13/2.19	ns
		XC6SLX25	0.18/1.64	0.18/1.75	0.18/1.99	0.11/2.57	ns
		XC6SLX25T	0.18/1.64	0.18/1.75	0.18/1.99	N/A	ns
		XC6SLX45	-0.08/1.80	-0.08/1.95	-0.08/2.27	-0.17/2.74	ns
		XC6SLX45T	-0.08/1.80	-0.08/1.95	-0.08/2.27	N/A	ns
		XC6SLX75	0.13/1.81	0.13/2.06	0.13/2.27	-0.12/3.30	ns
		XC6SLX75T	0.13/1.81	0.13/2.06	0.13/2.27	N/A	ns
		XC6SLX100	-0.14/2.03	-0.14/2.24	-0.14/2.56	-0.17/3.44	ns
		XC6SLX100T	-0.14/2.03	-0.14/2.24	-0.14/2.56	N/A	ns
		XC6SLX150	-0.24/2.42	-0.24/2.74	-0.24/2.95	-0.60/3.75	ns
		XC6SLX150T	-0.24/2.42	-0.24/2.74	-0.24/2.95	N/A	ns
		XA6SLX4	0.10/1.57	N/A	0.10/1.84	N/A	ns
		XA6SLX9	0.10/1.57	N/A	0.10/1.84	N/A	ns
		XA6SLX16	0.12/1.43	N/A	0.12/1.64	N/A	ns
		XA6SLX25	0.18/1.65	N/A	0.18/1.99	N/A	ns
		XA6SLX25T	0.18/1.65	N/A	0.18/1.99	N/A	ns
		XA6SLX45	-0.08/1.82	N/A	-0.08/2.27	N/A	ns
		XA6SLX45T	-0.08/1.82	N/A	-0.08/2.27	N/A	ns
		XA6SLX75	0.13/2.02	N/A	0.13/2.32	N/A	ns
		XA6SLX75T	0.13/2.02	N/A	0.13/2.32	N/A	ns
		XA6SLX100	N/A	N/A	0.10/2.51	N/A	ns
		XQ6SLX75	N/A	N/A	0.13/2.32	-0.12/3.30	ns
		XQ6SLX75T	0.13/2.02	N/A	0.13/2.32	N/A	ns
		XQ6SLX150	N/A	N/A	-0.24/2.95	-0.60/3.75	ns
		XQ6SLX150T	-0.24/2.74	N/A	-0.24/2.95	N/A	ns

**Notes:**

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage.
2. IFF = Input Flip-Flop or Latch.

Table 72: Global Clock Setup and Hold With DCM in System-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
<b>Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMOS25 Standard.<sup>(1)</sup></b>							
T <sub>PSDCM</sub> / T <sub>PHDCM</sub>	No Delay Global Clock and IFF <sup>(2)</sup> with DCM in System-Synchronous Mode	XC6SLX4	1.54/0.06	N/A	1.75/0.12	2.84/0.27	ns
		XC6SLX9	1.54/0.06	1.63/0.12	1.75/0.12	2.84/0.27	ns
		XC6SLX16	1.72/-0.18	1.87/-0.17	2.13/-0.17	2.31/0.26	ns
		XC6SLX25	1.70/-0.03	1.78/-0.02	2.00/-0.02	2.88/0.20	ns
		XC6SLX25T	1.70/0.07	1.78/0.08	2.00/0.08	N/A	ns
		XC6SLX45	1.74/-0.03	1.84/-0.02	2.02/-0.02	2.64/0.52	ns
		XC6SLX45T	1.74/-0.01	1.84/0.00	2.02/0.00	N/A	ns
		XC6SLX75	1.86/0.11	1.98/0.12	2.20/0.12	2.96/0.58	ns
		XC6SLX75T	1.86/0.11	1.98/0.12	2.20/0.12	N/A	ns
		XC6SLX100	1.64/0.07	1.72/0.08	1.97/0.08	2.70/0.99	ns
		XC6SLX100T	1.64/0.09	1.72/0.10	1.97/0.10	N/A	ns
		XC6SLX150	1.53/0.39	1.62/0.40	1.82/0.40	2.75/1.00	ns
		XC6SLX150T	1.53/0.39	1.62/0.40	1.82/0.40	N/A	ns
		XA6SLX4	1.65/0.16	N/A	1.75/0.26	N/A	ns
		XA6SLX9	1.65/0.16	N/A	1.75/0.26	N/A	ns
		XA6SLX16	1.88/0.02	N/A	2.13/0.03	N/A	ns
		XA6SLX25	1.80/0.16	N/A	2.05/0.17	N/A	ns
		XA6SLX25T	1.80/0.16	N/A	2.13/0.17	N/A	ns
		XA6SLX45	1.75/0.12	N/A	2.02/0.13	N/A	ns
		XA6SLX45T	1.75/0.12	N/A	2.02/0.13	N/A	ns
		XA6SLX75	1.87/0.11	N/A	2.20/0.12	N/A	ns
		XA6SLX75T	1.87/0.11	N/A	2.20/0.12	N/A	ns
		XA6SLX100	N/A	N/A	2.46/0.24	N/A	ns
		XQ6SLX75	N/A	N/A	2.20/0.12	2.96/0.58	ns
		XQ6SLX75T	1.87/0.11	N/A	2.20/0.12	N/A	ns
		XQ6SLX150	N/A	N/A	1.82/0.56	2.75/1.00	ns
		XQ6SLX150T	1.65/0.55	N/A	1.82/0.56	N/A	ns

**Notes:**

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage. These measurements include DCM CLK0 jitter.
2. IFF = Input Flip-Flop or Latch
3. Use IBIS to determine any duty-cycle distortion incurred using various standards.

Table 75: Global Clock Setup and Hold With PLL in Source-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
<b>Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMOS25 Standard.<sup>(1)</sup></b>							
T <sub>PSPLL0</sub> / T <sub>PHPPLL0</sub>	No Delay Global Clock and IFF <sup>(2)</sup> with PLL in Source-Synchronous Mode	XC6SLX4	0.47/1.08	N/A	0.47/1.60	1.15/1.68	ns
		XC6SLX9	0.47/1.08	0.47/1.35	0.47/1.60	1.15/1.68	ns
		XC6SLX16	0.37/0.75	0.37/0.82	0.51/0.94	0.57/1.31	ns
		XC6SLX25	0.69/1.06	0.69/1.06	0.69/1.06	1.86/1.67	ns
		XC6SLX25T	0.69/1.06	0.69/1.06	0.69/1.06	N/A	ns
		XC6SLX45	0.57/1.05	0.65/1.10	0.65/1.18	1.02/1.65	ns
		XC6SLX45T	0.57/1.06	0.65/1.10	0.65/1.18	N/A	ns
		XC6SLX75	0.86/1.04	0.87/1.04	0.90/1.04	1.34/1.55	ns
		XC6SLX75T	0.86/1.04	0.87/1.04	0.90/1.04	N/A	ns
		XC6SLX100	0.53/1.13	0.54/1.13	0.55/1.13	0.89/2.39	ns
		XC6SLX100T	0.53/1.13	0.54/1.13	0.55/1.13	N/A	ns
		XC6SLX150	0.50/1.31	0.51/1.31	0.52/1.31	1.02/1.72	ns
		XC6SLX150T	0.50/1.31	0.51/1.31	0.52/1.31	N/A	ns
		XA6SLX4	0.71/0.93	N/A	0.62/1.47	N/A	ns
		XA6SLX9	0.71/0.93	N/A	0.62/1.47	N/A	ns
		XA6SLX16	0.92/0.69	N/A	0.63/0.82	N/A	ns
		XA6SLX25	0.99/0.94	N/A	0.96/0.94	N/A	ns
		XA6SLX25T	0.99/0.94	N/A	1.04/0.94	N/A	ns
		XA6SLX45	0.63/1.02	N/A	0.72/1.05	N/A	ns
		XA6SLX45T	0.63/1.02	N/A	0.72/1.05	N/A	ns
		XA6SLX75	0.88/0.89	N/A	1.02/0.89	N/A	ns
		XA6SLX75T	0.88/0.89	N/A	1.02/0.89	N/A	ns
		XA6SLX100	N/A	N/A	1.25/0.96	N/A	ns
		XQ6SLX75	N/A	N/A	1.02/0.89	1.34/1.55	ns
		XQ6SLX75T	0.88/0.89	N/A	1.02/0.89	N/A	ns
		XQ6SLX150	N/A	N/A	0.63/1.19	1.02/1.72	ns
		XQ6SLX150T	0.60/1.19	N/A	0.63/1.19	N/A	ns

**Notes:**

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage. These measurements include PLL CLKOUT0 jitter.
2. IFF = Input Flip-Flop or Latch
3. Use IBIS to determine any duty-cycle distortion incurred using various standards.

## Source-Synchronous Switching Characteristics

The parameters in this section provide the necessary values for calculating timing budgets for Spartan-6 FPGA source-synchronous transmitter and receiver data-valid windows.

**Table 78: Duty Cycle Distortion and Clock-Tree Skew**

Symbol	Description	Device <sup>(1)</sup>	Speed Grade				Units
			-3	-3N	-2	-1L	
$T_{DCD\_CLK}$	Global Clock Tree Duty Cycle Distortion <sup>(2)</sup>	LX4	0.20	N/A	0.20	0.35	ns
		LX9	0.20	0.20	0.20	0.35	ns
		LX16	0.20	0.20	0.20	0.35	ns
		LX25	0.20	0.20	0.20	0.35	ns
		LX25T	0.20	0.20	0.20	N/A	ns
		LX45	0.20	0.20	0.20	0.35	ns
		LX45T	0.20	0.20	0.20	N/A	ns
		LX75	0.20	0.20	0.20	0.35	ns
		LX75T	0.20	0.20	0.20	N/A	ns
		LX100	0.20	0.20	0.20	0.35	ns
		LX100T	0.20	0.20	0.20	N/A	ns
		LX150	0.35	0.35	0.35	0.35	ns
		LX150T	0.35	0.35	0.35	N/A	ns
$T_{CKSKEW}$	Global Clock Tree Skew <sup>(3)</sup>	LX4	0.25	N/A	0.25	0.29	ns
		LX9	0.25	0.25	0.25	0.29	ns
		LX16	0.15	0.15	0.15	0.22	ns
		LX25	0.26	0.26	0.26	0.41	ns
		LX25T	0.26	0.26	0.26	N/A	ns
		LX45	0.20	0.20	0.20	0.28	ns
		LX45T	0.20	0.20	0.20	N/A	ns
		LX75	0.56	0.56	0.56	0.50	ns
		LX75T	0.56	0.56	0.56	N/A	ns
		XC6SLX100 <sup>(4)</sup>	0.22	0.22	0.22	0.21	ns
		XA6SLX100 <sup>(4)</sup>	N/A	N/A	0.43	N/A	ns
		LX100T	0.22	0.22	0.22	N/A	ns
		LX150	0.48	0.48	0.48	0.35	ns
		LX150T	0.48	0.48	0.48	N/A	ns
$T_{DCD\_BUFIO2}$	I/O clock tree duty cycle distortion	LX devices	0.25	0.25	0.25	0.50	ns
		LXT devices	0.25	0.25	0.25	N/A	ns

Table 78: Duty Cycle Distortion and Clock-Tree Skew (Cont'd)

Symbol	Description	Device <sup>(1)</sup>	Speed Grade				Units
			-3	-3N	-2	-1L	
$T_{BUFIOSKEW}$	I/O clock tree skew across one clock region	LX4	0.06	N/A	0.06	0.07	ns
		LX9	0.06	0.06	0.06	0.07	ns
		LX16	0.06	0.06	0.06	0.07	ns
		LX25	0.06	0.06	0.06	0.07	ns
		LX25T	0.06	0.06	0.06	N/A	ns
		LX45	0.06	0.06	0.06	0.07	ns
		LX45T	0.06	0.06	0.06	N/A	ns
		LX75	0.06	0.06	0.06	0.07	ns
		LX75T	0.06	0.06	0.06	N/A	ns
		LX100	0.06	0.06	0.06	0.07	ns
		LX100T	0.06	0.06	0.06	N/A	ns
		LX150	0.06	0.06	0.06	0.07	ns
		LX150T	0.06	0.06	0.06	N/A	ns

**Notes:**

1. LXT devices are not available with a -1L speed grade. The LX4 is not available in -3N speed grade.
2. These parameters represent the worst-case duty cycle distortion observable at the pins of the device using LVDS output buffers. For cases where other I/O standards are used, IBIS can be used to calculate any additional duty cycle distortion that might be caused by asymmetrical rise/fall times.
3. The  $T_{CKSKEW}$  value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA Editor and Timing Analyzer tools to evaluate clock skew specific to your application.
4. The  $T_{CKSKEW}$  is 0.43 ns for the XA6SLX100 device using a -2 speed grade and 0.22 ns for the XC6SLX100 devices using the -2 speed grade.

Table 79: Package Skew

Symbol	Description	Device	Package <sup>(2)</sup>	Value	Units
$T_{PKGSKEW}$	Package Skew <sup>(1)</sup>	LX4	TQG144	N/A	ps
			CPG196	23	ps
			CSG225	58	ps
		LX9	TQG144	N/A	ps
			CPG196	23	ps
			CSG225	58	ps
			FT(G)256	88	ps
			CSG324	64	ps
		LX16	CPG196	19	ps
			CSG225	70	ps
			FT(G)256	71	ps
			CSG324	54	ps
		LX25	FT(G)256	90	ps
			CSG324	61	ps
			FG(G)484	84	ps
		LX25T	CSG324	48	ps
			FG(G)484	112	ps

## Revision History

The following table shows the revision history for this document.

Date	Version	Description of Revisions
06/24/09	1.0	Initial Xilinx release.
08/26/09	1.1	Added $V_{FS}$ to <a href="#">Table 1</a> and <a href="#">Table 2</a> . Added $R_{FUSE}$ to <a href="#">Table 2</a> . Added XC6SLX75 and XC6SLX75T to $V_{BATT}$ and $I_{BATT}$ in <a href="#">Table 1</a> , <a href="#">Table 2</a> , and <a href="#">Table 4</a> . Corrected the quiescent supply current for the XC6SLX4 in <a href="#">Table 5</a> . Updated <a href="#">Table 11</a> . Removed $DV_{PPIN}$ from <a href="#">Figure 2</a> . Removed $F_{PCIECORE}$ from <a href="#">Table 24</a> and added values to $F_{PCIEUSER}$ . Added more networking applications to <a href="#">Table 25</a> . Updated values for $T_{SUSPENDLOW\_AWAKE}$ , $T_{SUSPEND\_ENABLE}$ , and $T_{SCP\_AWAKE}$ in <a href="#">Table 46</a> . Numerous changes to <a href="#">Table 47, page 54</a> including the addition of new values to various specifications, revising the $T_{SMCKCSO}$ description, and changing the units of $T_{POR}$ . Also, removed <i>Dynamic Reconfiguration Port (DRP) for DCM and PLL Before and After DCLK section</i> from <a href="#">Table 47</a> and updated all the notes. In <a href="#">Table 52</a> , added to $F_{INMAX}$ , revised $F_{OUTMAX}$ , and removed PLL Maximum Output Frequency for BUFI02. Revised values for DCM_DELAY_STEP in <a href="#">Table 54</a> . Updated CLKIN_FREQ_FX values in <a href="#">Table 55</a> .
01/04/10	1.2	Added -4 speed grade to entire document. Updated speed specification of -4, -3, -2 speed grades to version 1.03. Added -1L speed grade numbers per speed specification 1.00. Updated $T_{SOL}$ in <a href="#">Table 1</a> . Added -1L rows for LVCMOS12, LVCMOS15, and LVCMOS18 in <a href="#">Table 9</a> . Revised much of the detail in <a href="#">GTP Transceiver Specifications</a> in <a href="#">Table 12</a> through <a href="#">Table 23</a> . Added -2 data to <a href="#">Table 25</a> . Updated $F_{MAX}$ in <a href="#">Table 44</a> . Updated descriptions for $T_{DNACLKL}$ and $T_{DNACLKH}$ in <a href="#">Table 45</a> and revised values for all parameters. Removed $T_{INITADDR}$ from <a href="#">Table 47</a> and added new data. Updated values in <a href="#">Table 48</a> through <a href="#">Table 62</a> . Added <a href="#">Table 51</a> (BUFPLL) and <a href="#">Table 57</a> (DCM_CLKGEN). Removed $T_{LOCKMAX}$ note from <a href="#">Table 52</a> . Updated note 3 in <a href="#">Table 53</a> . In <a href="#">Table 79</a> : removed XC6SLX75CSG324 and XC6SLX75TCG324; added XC6SLX75FG(G)484 and XC6SLX75FG(G)484.
02/22/10	1.3	Production release of XC6SLX16 -2 speed grade devices. The changes to <a href="#">Table 26</a> and <a href="#">Table 27</a> includes updating this data sheet to the data in ISE v11.5 software with speed specification v1.06. Updated maximum of $V_{IN}$ and $V_{TS}$ and note 2 in <a href="#">Table 1</a> . In <a href="#">Table 2</a> , changed $V_{IN}$ , added $I_{IN}$ and note 5, revised notes 1, 6, and 7, and added note 8 to $R_{FUSE}$ . In <a href="#">Table 4</a> , removed previous note 1 and added data to $I_{RPU}$ , $I_{RPD}$ , and $I_{BATT}$ ; changed $C_{IN}$ , added $R_{DT}$ and $R_{IN\_TERM}$ , and added note 2 and 3. Updated $V_{CCO2}$ in <a href="#">Table 6</a> . Added <a href="#">Table 7</a> and <a href="#">Table 8</a> . Removed PCI66_3 from <a href="#">Table 9</a> . Updated PCI33_3 and I2C in <a href="#">Table 9</a> . Updated the description of <a href="#">Table 11</a> . Completely updated <a href="#">Table 25</a> . Updated <a href="#">Table 28</a> including adding values for PCI33_3. Updated $V_{REF}$ value for HSTL_III_18 in <a href="#">Table 31</a> . Updates missing $V_{REF}$ values in <a href="#">Table 32</a> . Added <a href="#">Simultaneously Switching Outputs, page 36</a> . Removed $T_{GSRQ}$ and $T_{RPW}$ from <a href="#">Table 35</a> and <a href="#">Table 36</a> . Also removed $T_{DOQ}$ from <a href="#">Table 36</a> . Removed $T_{ISPO\_DO}$ and note 1 from <a href="#">Table 37</a> . Removed $T_{OSCCK\_S}$ and combinatorial section from <a href="#">Table 38</a> . In <a href="#">Table 39</a> , removed $T_{IODDO\_T}$ and added new tap parameters and note 2. In <a href="#">Table 40</a> , <a href="#">Table 41</a> , and <a href="#">Table 42</a> , made typographical edits and removed notes. Removed clock CLK section in <a href="#">Table 41</a> . Removed clock CLK section and $T_{REG\_MUX}$ and $T_{REG\_M31}$ in <a href="#">Table 42</a> . Added block RAM $F_{MAX}$ values to <a href="#">Table 43</a> . Updated values and added note 2 to <a href="#">Table 45</a> . Added values to <a href="#">Table 46</a> and removed note 1. Numerous changes to <a href="#">Table 47</a> . Completely updated <a href="#">Table 57</a> . Revised data in <a href="#">Table 62</a> . Removed note 3 from <a href="#">Table 71</a> . Added values to <a href="#">Table 79</a> . Added data to <a href="#">Table 80</a> and <a href="#">Table 81</a> .
03/10/10	1.4	Production release of XC6SLX45 -2 speed grade devices, which includes changes to <a href="#">Table 26</a> and <a href="#">Table 27</a> updating this data sheet to the data in ISE v11.5 software with speed specification v1.07. Fixed $R_{IN\_TERM}$ description in <a href="#">Table 4</a> . Added PCI66_3 to <a href="#">Table 7</a> and replaced note 1. Corrected note 1 and the V <sub>Max</sub> for TMDS_33 in <a href="#">Table 8</a> . In <a href="#">Table 10</a> , added note 1 to LVPECL_33 and TMDS_33. Also updated specifications for TMDS_33. Updated the <a href="#">GTP Transceiver Specifications</a> section including adding values to <a href="#">Table 16</a> , <a href="#">Table 17</a> , and <a href="#">Table 20</a> through <a href="#">Table 23</a> . Added PCI66_3 back into <a href="#">Table 9</a> , <a href="#">Table 28</a> , <a href="#">Table 31</a> , <a href="#">Table 32</a> , and <a href="#">Table 34</a> . Updated note 3 on <a href="#">Table 32</a> . In <a href="#">Table 34</a> , corrected some typographical errors and fixed SSO limits for bank1/3 in FG(G)484 package. Corrected $T_{OSCCK\_OC_E}$ in <a href="#">Table 38</a> . In <a href="#">Table 57</a> , updated CLKFX_FREEZE_VAR and CLKFX_FREEZE_TEMP_SLOPE and added typical values to $T_{CENTER\_LOW\_SPREAD}$ and $T_{CENTER\_HIGH\_SPREAD}$ . Updated and added values to <a href="#">Table 63</a> through <a href="#">Table 78</a> , and <a href="#">Table 81</a> . In <a href="#">Table 79</a> , revised the XC6SLX16-CSG324 and the XC6SLX45-CSG484 and FG(G)484 values.

Date	Version	Description of Revisions
01/10/11	1.11	<p>Production release of XC6SLX4 and XC6SLX9 in the specific speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v12.4 software with speed specification v1.15 for the -4, -3, -3N, and -2 speed grades. Added note 3 to <a href="#">Table 27</a>. Also updated the -1L speed grade requirements to ISE v12.4 software with speed specification v1.06. Revised -3N definition throughout the document.</p> <p>Added note 4 to <a href="#">Table 2</a> and updated note 5. Added information on <math>V_{CCINT}</math> to note 1 in <a href="#">Table 5</a>. Updated Networking Applications -3 values in <a href="#">Table 25</a> to match improvements made in ISE v12.4. In <a href="#">Table 28</a>, added note 1 and revised the <math>T_{IOTP}</math> values for LVDS_33, LVDS_25, MINI_LVDS_33, MINI_LVDS_25, RSDS_33, RSDS_25, TMDS_33, PPDS_33, and PPDS_25. Added note 3 to <a href="#">Table 55</a>.</p>
02/11/11	1.12	<p>As described in <a href="#">XCN11008: Product Discontinuation Notice For Spartan-6 LXT -4 Devices</a>, the -4 speed specifications have been discontinued. As outlined in page 2 of the XCN, designers currently using -4 speed specifications should rerun timing analysis using the new -3 speed specifications before moving to a replacement device.</p> <p>Updated the networking applications section of <a href="#">Table 25</a>. Updated -2 speed specifications throughout document and added note 3 to <a href="#">Table 27</a> advising designers to use the -2 speed specification update (v1.17) with the ISE 12.4 software patch. Added <math>F_{CLKDIV}</math> to <a href="#">Table 37</a> and <a href="#">Table 38</a>. Updated note 2 in <a href="#">Table 39</a>. Updated units for <math>T_{SMCKCSO}</math> and <math>T_{BPICCO}</math> in <a href="#">Table 47</a>. Updated -1L in <a href="#">Table 71</a>. Removed Note 2: <i>Package delay information is available for these device/package combinations. This information can be used to deskew the package from Table 79.</i></p>
03/31/11	2.0	<p>Production release of XC6SLX45 in the -1L speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.1 software with -1L speed specification v1.06.</p> <p>In <a href="#">Table 39</a>, removed values in the -1L column and added note 3 as IODELAY2 only supports Tap0 for lower-power devices. Updated copyright <a href="#">page 1</a> and <a href="#">Notice of Disclaimer</a>.</p>
05/20/11	2.1	<p>Production release of XC6SLX100 and XC6SLX150 in the specific speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.1 software with -1L speed specification v1.06. Updated <a href="#">Table 27</a> and <a href="#">Note 7</a> with changes per <a href="#">XCN11012: Speed File Change for -3N Devices</a>. Revised <a href="#">Switching Characteristics</a> section for speed specifications: v1.18 for -3, -3N, and -2; including improvements in <a href="#">Table 73</a> through <a href="#">Table 77</a> and <a href="#">Table 81</a>.</p> <p>Removed <i>Memory Controller Block</i> from the performance heading in <a href="#">Table 2</a> and revised <a href="#">Note 2</a>. In <a href="#">Table 4</a>, added <a href="#">Note 1</a> to <math>C_{IN}</math> and updated the description of <math>R_{IN\_TERM}</math>. Updated <a href="#">Note 1</a> in <a href="#">Table 5</a>. Updated <a href="#">Note 1</a> of <a href="#">Table 7</a>. In <a href="#">Table 25</a>, added and removed -1L specifications, increased the standard performance DDR3 specifications, removed the extended performance DDR3 row and updated <a href="#">Note 3</a> and <a href="#">Note 4</a>. Clarified the introductory information for <a href="#">Table 28</a> and <a href="#">Table 30</a>.</p> <p>In <a href="#">Table 32</a>: Revised <math>V_{MEAS}</math> value for LVCMOS12; revised <math>V_{REF}</math> for LVDS_25, LVDS_33, BLVDS_25, MINI_LVDS_25, MINI_LVDS_33, RSDS_25, and RSDS_33; revised <math>R_{REF}</math> for BLVDS_25 and TMDS_33; and added <a href="#">Note 4</a> and <a href="#">Note 5</a>. Updated <a href="#">Note 2</a> and <a href="#">Note 3</a> in <a href="#">Table 39</a>.</p> <p>In <a href="#">Table 47</a>, revised the values and description of <math>T_{POR}</math> including adding <a href="#">Note 3</a>. Also in <a href="#">Table 47</a>, augmented the description and added specifications for <math>F_{RBCK}</math> and removed XC6SLX4 from <math>F_{MCCK}</math> (maximum frequency, parallel mode (Master SelectMAP/BPI)). Added BUFGMUX to <a href="#">Table 48</a> title. Added <a href="#">Table 50</a>.</p> <p>In <a href="#">Table 52</a>, revised specifications for <math>T_{EXTFDVAR}</math> and <math>F_{INJITTER}</math>. In <a href="#">Table 54</a> removed the 5 MHz &lt; <math>CLKIN\_FREQ\_DLL</math> parameter in the <math>LOCK\_DLL</math> description. In both <a href="#">Table 56</a> and <a href="#">Table 57</a>, removed the 5 MHz &lt; <math>F_{CLKIN}</math> parameter in the <math>LOCK\_FX</math> description. In <a href="#">Table 58</a>, updated description for <math>PSCLK\_FREQ</math> and <math>PSCLK\_PULSE</math>.</p> <p>Revised title and symbol of <a href="#">Table 70</a>, added new speed specifications for -1L, and added <a href="#">Note 2</a>. Added <a href="#">Table 71</a>.</p>
07/11/11	2.2	<p>Added the Automotive XA Spartan-6 and Defense-grade Spartan-6Q devices to all appropriate tables while sometimes removing the XC6S nomenclature. Added expanded temperature range (Q) to all appropriate tables. Updated <math>T_{SOL}</math> packages in <a href="#">Table 1</a>. Added <math>R_{OUT\_TERM}</math> to <a href="#">Table 4</a>. Updated <a href="#">Note 2</a> on <a href="#">Table 13</a>.</p> <p>Production release of the XC6SLX4, XC6SLX9, XC6SLX16, XC6SLX25, XC6SLX75, XQ6SLX75, and XQ6SLX150 in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.2 software with -1L speed specification v1.07.</p> <p>Production release of the XA6SLX16, XA6SLX25T, XA6SLX45, XA6SLX45T, XQ6SLX75, XQ6SLX75T, XQ6SLX150, and XQ6SLX150T in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.2 software with -2 and -3 speed specification v1.19.</p> <p>Added <a href="#">Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices(1)</a>. Updated CS(G)484 from CSG484 throughout data sheet. Clarified <a href="#">Note 3</a> in <a href="#">Table 39</a>.</p>
08/08/11	2.3	Production release of the XA6SLX25, XA6SLX75, and XA6SLX75T in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.2 software with -2 and -3 speed specification v1.19.